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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application:	Tomoo Yamasaki et al.	]	GRP ART UNIT: 2823
		]	
Serial No:	10/776,864	]	Ex.: Coleman, William D.
		]	
Filed:	February 10, 2004	]	
		]	
For:	Substrate Fabrication Method and Substrate		

Mail Stop Amendment  
The Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

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August 11, 2005  
Date

*M-Pomroy*  
Maggie Pomroy

**AMENDMENT**

Sir:

In response to the Office Action mailed May 17, 2005 for the above-identified patent application, please amend the application as follows:

**Amendments to the Drawings** begin on page 2 of this paper and include an attached replacement sheet and an attached annotated sheet showing the revisions.

**Remarks/Argument** begin on page 3 of this paper.